

N-Channel PowerTrench[®] MOSFET 40V, 50A, 6.7m Ω

Features

- Max $r_{DS(on)} = 6.7 m\Omega$ at $V_{GS} = 10V$, $I_D = 15A$
- Max $r_{DS(on)} = 8.7 m\Omega$ at $V_{GS} = 4.5 V$, $I_D = 13 A$
- HBM ESD protection level >7kV typical (Note 4)
- RoHS Compliant

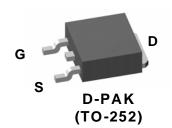


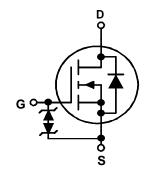
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

Applications

- Inverter
- Synchronous Rectifier





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous (Package limited)	T _C = 25°C		50		
	-Continuous (Silicon limited)	T _C = 25°C		75		
	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	16.4	Α	
	-Pulsed			100	_	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	253	mJ	
P _D	Power Dissipation	T _C = 25°C		65	14/	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.1	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.9	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Not	e 1a) 40	C/vv

Package Marking and Ordering Information

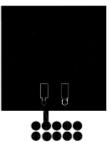
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8453LZ	FDD8453LZ	D-PAK (TO-252)	13"	16mm	2500 units

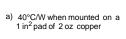
March 2015

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		36		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32V, V_{GS} = 0V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±10	μA
On Chara	cteristics			-i		-
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	1.0	1.8	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-6.0		mV/°C
		V _{GS} = 10V, I _D = 15A		5.8	6.7	
		$V_{GS} = 4.5V, I_D = 13A$		6.8	8.7	-
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 15A,$ $T_{,1} = 125^{\circ}C$		9.1	10.6	- mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 15A		77		S
Dynamic C _{iss}	Characteristics			2640	3515	pF
C _{oss}	Output Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$		320	425	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		190	285	pF
R _q	Gate Resistance	f = 1MHz		2.3		Ω
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time			11	19	ns
t _r	Rise Time	$V_{DD} = 20V, I_D = 15A,$		6	12	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GS}$ = 10V, R_{GEN} = 6 Ω		37	58	ns
t _f	Fall Time			5	10	ns
Qg	Total Gate Charge	$V_{GS} = 0V$ to 10V		46	64	nC
Qg	Total Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 20V,$		24	33	nC
Q _{gs}	Gate to Source Charge	$I_{\rm D} = 15A$		7		nC
Q _{gd}	Gate to Drain "Miller" Charge			8		nC
Drain-Sou	urce Diode Characteristics					
\/		V _{GS} = 0V, I _S = 2.0A (Note 2)		0.7	1.2	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 15A$ (Note 2)		0.8	1.3	v
	D D T	-		25	40	ns
t _{rr}	Reverse Recovery Time	I _F = 15A, di/dt = 100A/μs		25	40	115

Notes:

1: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JA} is guaranteed by design while R_{0JA} is determined by the user's board design.



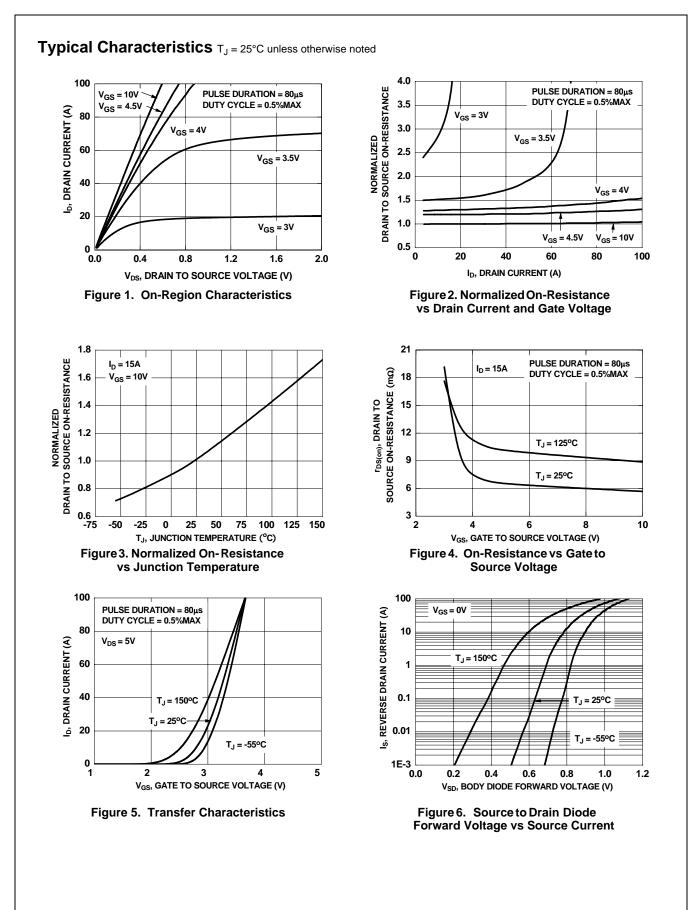


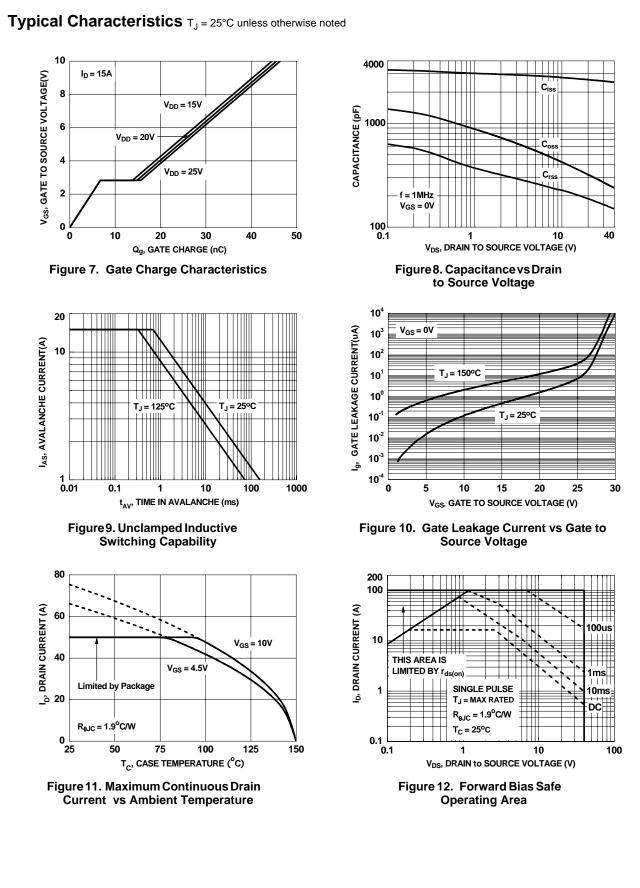


Q

b) 96°C/W when mounted on a minimum pad.

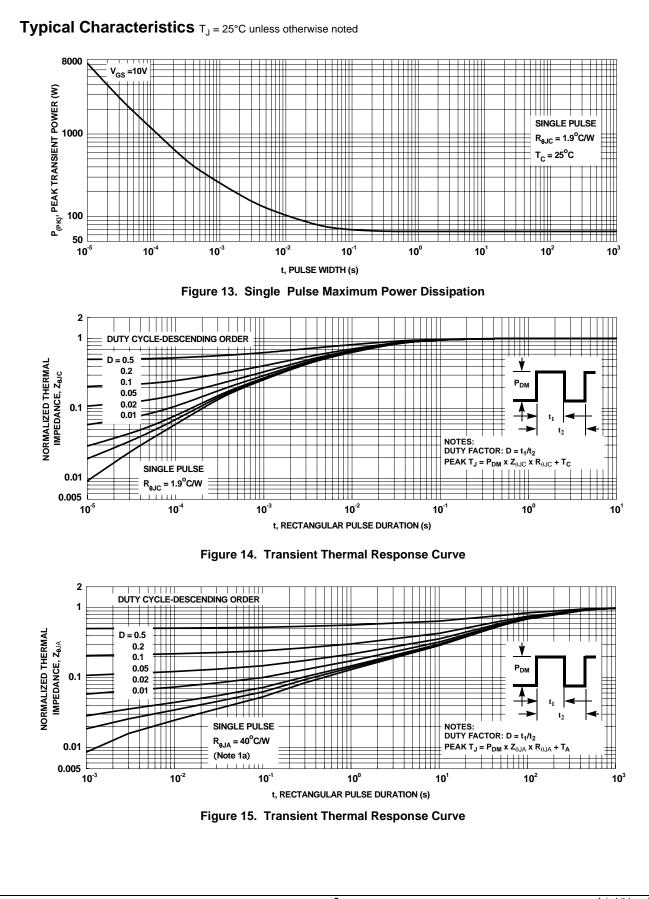
Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.
Starting T_J = 25°C, L = 3mH, I_{AS} = 13A, V_{DD} = 40V, V_{GS} = 10V.
The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



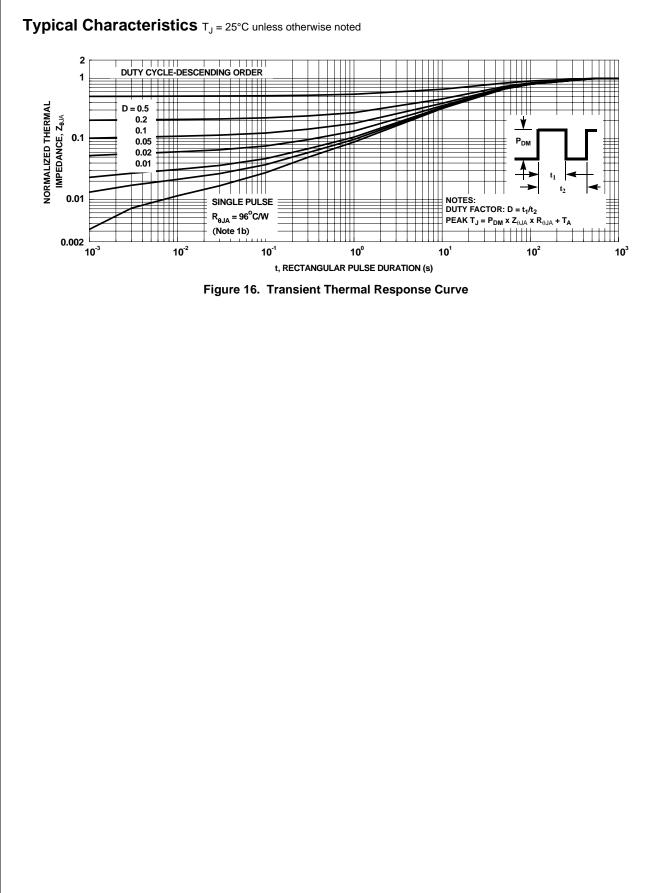


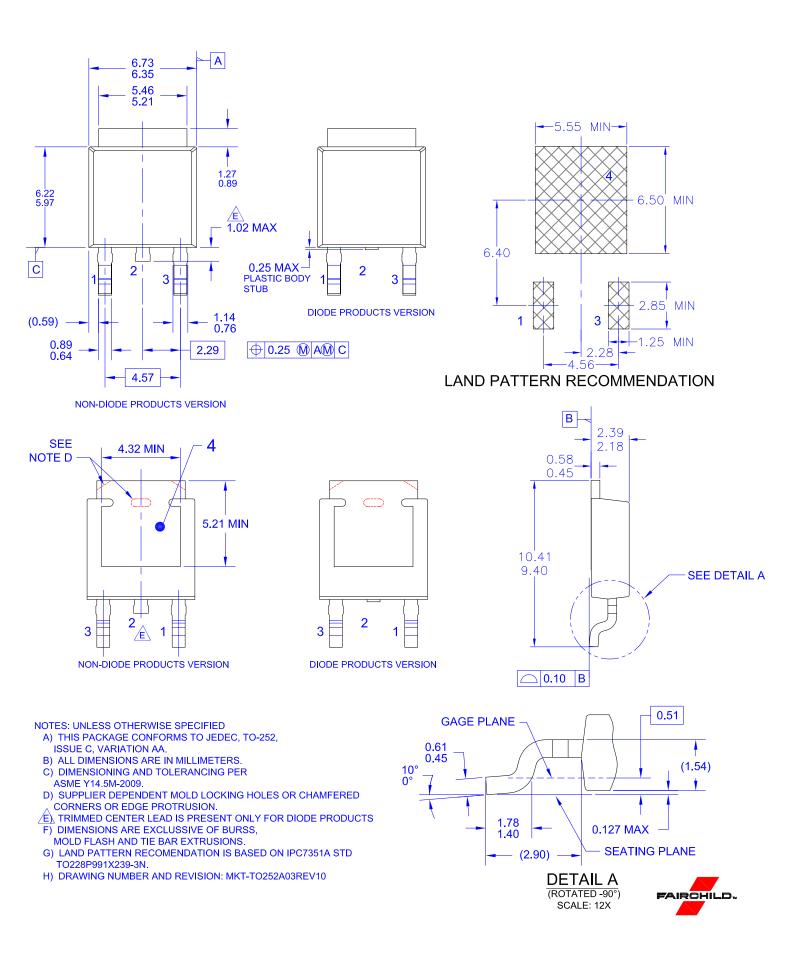
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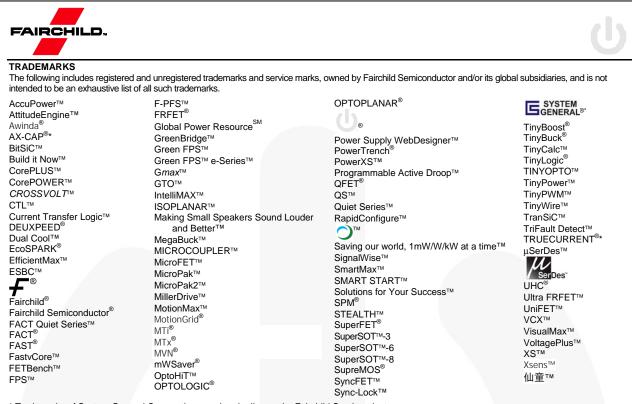
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